## WHAT IS CLAIMED IS

20

- 1. A laminate for IR ablation comprising at least a substrate and an IR ablation layer, wherein the aforementioned IR ablation layer comprises an IR absorbent metal layer.
- 2. The laminate for IR ablation of claim 1, wherein the IR absorbent metal layer is a metal deposition layer.
- 3. The laminate for IR ablation of claim 1, which further comprises an anti-blocking layer on the opposite side of the IR ablation layer of the substrate.
- 4. The laminate for IR ablation of claim 1, which further comprises a release layer between the substrate and the IR ablation layer.
  - 5. The laminate for IR ablation of claim 3, wherein the antiblocking layer comprises a thermosetting resin.
  - 6. The laminate for IR ablation of claim 3, wherein the antiblocking layer comprises an alkyd resin.
- 7. The laminate for IR ablation of claim 4, wherein the release layer comprises a thermosetting resin.
  - 8. The laminate for IR ablation of claim 4, wherein the release layer comprises an alkyd resin:
- 9. The laminate for IR ablation of claim 1, which further comprises an IR non-sensitive polymer resin layer between the substrate and the IR absorbent metal layer.

- 10. The laminate for IR ablation of claim 4, which further comprises an IR non-sensitive polymer resin layer between the release layer and the IR absorbent metal layer.
- <sup>5</sup> 11. A method for forming a mask on a photosensitive resin layer, which comprises a step of IR ablation of a laminate comprising at least a substrate and an IR ablation layer which is laminated on said photosensitive resin layer, wherein the IR ablation layer comprises an IR absorbent metal layer.

10

- 12. The method of claim 11, wherein the IR absorbent metal layer is a metal deposition layer.
- 13. The method of claim 11, wherein the laminate comprises an anti-blocking layer on the opposite side of an IR ablation layer of the substrate.
  - 14. The method of claim 11, wherein the laminate comprises a release layer between the substrate and the IR ablation layer.

20

- 15. The method of claim 13, wherein the anti-blocking layer comprises a thermosetting resin.
- 16. The method of claim 13, wherein the anti-blocking layer comprises an alkyd resin.
  - 17. The method of claim 14, wherein the release layer comprises a thermosetting resin.
- 30 18. The method of claim 14, wherein the release layer comprises an alkyd resin.
  - 19. The method of claim 11, wherein the laminate comprises an

IR non-sensitive polymer resin layer between the substrate and the IR absorbent metal layer.

20. The method of claim 14, wherein the laminate comprises an <sup>5</sup> IR non-sensitive polymer resin layer between the release layer and the IR absorbent metal layer.